

Error Detection/Correction Circuit

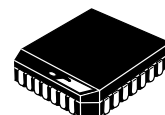
The MC10E193 is an error detection and correction (EDAC) circuit. Modified Hamming parity codes are generated on an 8-bit word according to the pattern shown in the logic symbol. The P5 output gives the parity of the whole word. The word parity is also provided at the PGEN pin, after Odd/Even parity control and gating with the BPAR input. This output also feeds to a 1-bit shiftable register, for use as part of a scan ring.

Used in conjunction with 12-bit parity generators such as the E160, a SECDED (single error correction, double error detection) error system can be designed for a multiple of an 8-bit word.

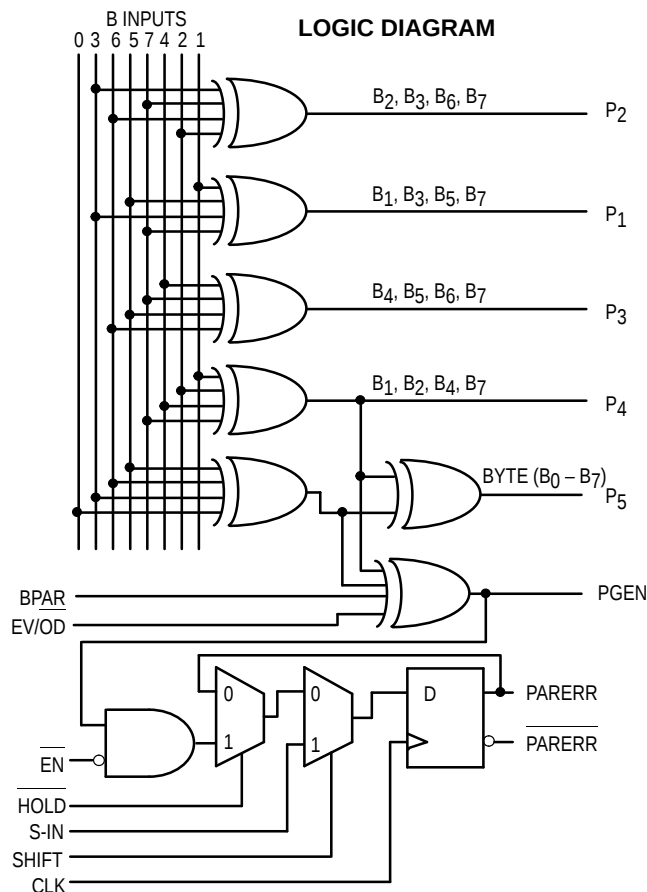
- Hamming Code Generation
- 8-Bit Word, Expandable
- Provides Parity of Whole Word
- Scannable Parity Register
- Extended 100E V_{EE} Range of $-4.2V$ to $-5.46V$
- $75k\Omega$ Input Pulldown Resistors

MC10E193
MC100E193

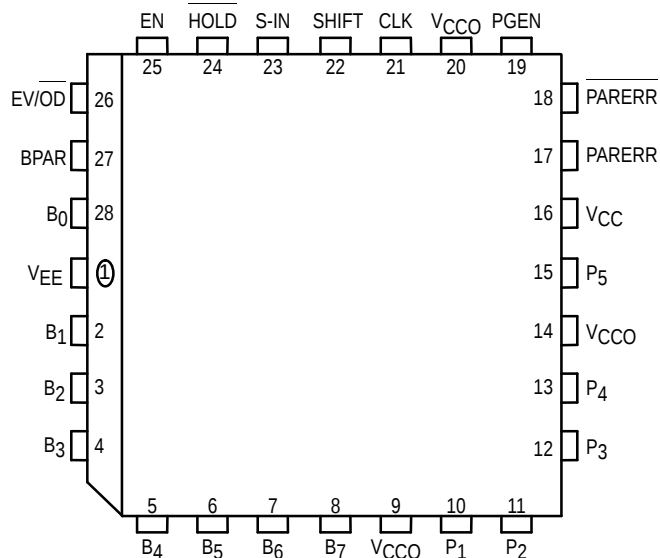
**ERROR DETECTION/
CORRECTION CIRCUIT**



FN SUFFIX
PLASTIC PACKAGE
CASE 776-02



Pinout: 28-Lead PLCC (Top View)



* All VCC and VCCO pins are tied together on the die.



DC CHARACTERISTICS ($V_{EE} = V_{EE(min)}$ to $V_{EE(max)}$; $V_{CC} = V_{CCO} = GND$)

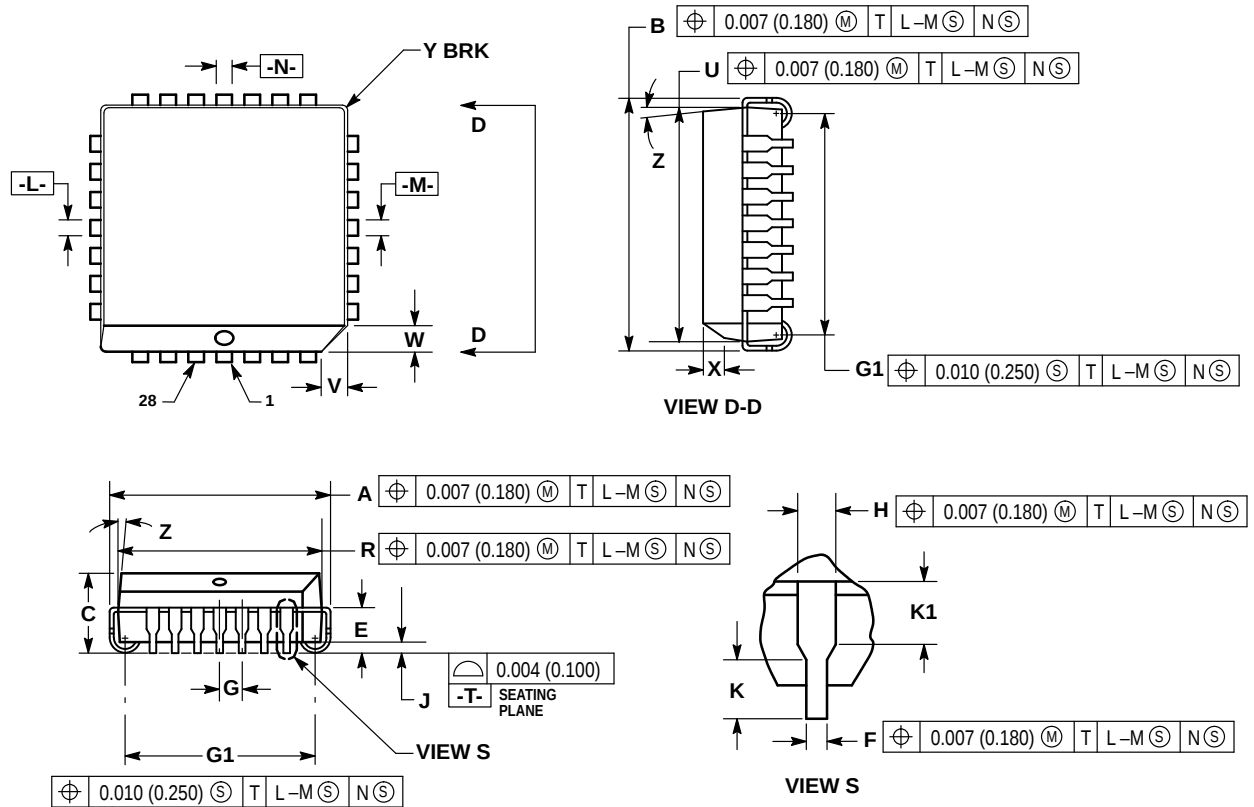
Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		min	typ	max	min	typ	max	min	typ	max		
I_{IH}	Input HIGH Current			150			150			150	μA	
I_{EE}	Power Supply Current										mA	
	10E		112	134		112	134		112	134		
	100E		112	134		112	134		129	155		

AC CHARACTERISTICS ($V_{EE} = V_{EE(min)}$ to $V_{EE(max)}$; $V_{CC} = V_{CCO} = GND$)

Symbol	Characteristic	0°C			25°C			85°C			Unit	Condition
		min	typ	max	min	typ	max	min	typ	max		
t_{PLH} t_{PHL}	Propagation Delay to Output B to P1, P2, P3, P4 B to <u>P5</u> EV/OD, BPAR to PGEN B to PGEN CLK to PARERR	350 400 350 600 300	700 775 650 1000 550	1000 1150 850 1450 850	350 400 350 600 300	700 775 650 1000 550	1000 1150 850 1450 850	350 400 350 600 300	700 775 650 1000 550	1000 1150 850 1450 850	ps	
t_s	Setup Time SHIFT <u>S-IN</u> HOLD EN ___ EV/OD BPAR B	400 300 750 500 1300 1300 1700	150 50 350 250 850 850 1100		400 300 750 500 1300 1300 1700	150 50 350 250 850 850 1100		400 300 750 500 1300 1300 1700	150 50 350 250 850 850 1100		ps	
t_h	Hold Time SHIFT <u>S-IN</u> HOLD EN ___ EV/OD BPAR B	200 300 100 100 -200 -200 -300	-150 -50 -350 -250 -850 -850 -1100		200 300 100 100 -200 -200 -300	-150 -50 -350 -250 -850 -850 -1100		200 300 100 100 -200 -200 -300	-150 -50 -350 -250 -850 -850 -1100		ps	
t_r t_f	Rise/Fall Times 20 - 80%	300	700	1100	300	700	1100	300	700	1100	ps	

OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 776-02
ISSUE D



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
- DIM G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIM R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.485	0.495	12.32	12.57
B	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	—	1.02	—

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